CONTACT

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FURTHER INFORMATION ON THE PRODUCTS

can be found in the Technical Data Sheets, Material Safety Data Sheets and Instructions for Use at www.DELO-adhesives.com/en/downloads. For application tests and any question you might have regarding the use of DELO products, please do not hesitate to contact our Engineering Department.

DISPENSING ADHESIVES

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n provided are based on tests performed under laboratory conditions. Heliable information about the behavior of the product under practical condi-ournose cannot be concluded from this. It is the customer's responsibility to test the suitability of a product for the intended purpose by considerin

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SELECTION CHART

DELO MONOPOX DELO DUALBOND

one-component · light-fixable/heat-curing

DELO MONOPOX, DELO DUALBOND (light-fixable & heat-curing)

Area of use Construction and structural adhe					ives Potting compounds and encapsulants						Low-temperature-curing adhesives					Die attach adhesives			
Product group		DELO MONOPOX			DELO DEL O MONOPO				X	DELO				DELO					DELO
Due due tree de		4.0000	0.10004		DUALBOND	050740	054045		05707	05705	DUALBOND	1 70004	1 70000	DUAL	BOND	DAOSS	DA0700	DA507	DUALBOND
Product code		AD286	SJ2981	H12860	SJ2718	GE2710	GE4815	GE6515	GE/2/	GE785	GE7045	L12224	L12238	LI 2208	LI 354	DA255	DA3760	DA587	DA2556
Chemical basis		amin. epoxy	amin. epoxy	amin. epoxy	amin. epoxy	amin. epoxy	acrylate	cation. epoxy	anhyd. epoxy	anhyd. epoxy	anhyd. epoxy	VLT	VLT	VLT	mCD	amin. epoxy	mCD	cation. epoxy	amin. epoxy
Color of cured product, in 1 mm layer thickness		silver-gray, opaque	beige, opaque	gray, opaque	beige, opaque	black, opaque, fluorescent	colorless, transparent	white, opaque	black, opaque	black, opaque	white, opaque	white, opaque, fluorescent	black, opaque	beige, opaque	black, opaque	gray, opaque	gray, opaque	white, opaque	brown, opaque
Filler		aluminum	minerals	aluminum	-	-	-	minerals	minerals	minerals	minerals	minerals	minerals	-	minerals	-	-	-	-
Density [g/cm ³] at room temperature		1.4	1.6	1.6	1.2	1.2	1.1	1.8	1.9	1.7	1.8	1.2	1.4	1.3	1.3	1.3	1.3	1.5	1.2
Viscosity [mPas] at +23 °C, rheometer	shear rate 2 1/s	240,000	830,000	250,000	42,000	11,000	10,000	19,000	27,000	600,000	130,000	70,000	48,000	2,400	610,000	78,000	164,000	76,000	55,000
	shear rate 10 1/s	140,000	340,000	110,000	24,000	8,000	6,000	10,000	18,000	180,000	28,000	20,000	21,000	1,500	145,000	33,000	74,000	31,000	30,000
Light fixation time [s] at 400 nm, 200 mW/cm ²		-	-	-	<5	-	_	-	-	-	5	-	-	<5	<5	-	-	-	<2
Processing time at +23 °C, 50 % r.h.		4 weeks	4 weeks	4 weeks	3 weeks	2 weeks	1 week	1 week	24 h	48 h	24 h	24 h	72 h	72 h	72 h	72 h	48 h	120 h	72 h
Min. curing temperature [°C]		+130	+120	+130	+90	+100	+110	+90	+125	+125	+125	+60	+60	+60	+80	+90	+100	+120	+90
Heat curing air convection oven, without heating time		75 min @ +130 °C 40 min @ +150 °C	40 min @ +150°C	40 min @ +150 °C	20 min @ +130 °C	30 min @ +130 °C	20 min @ +130 °C	15 min @ +130 °C	90 min @ +125 °C 20 min @ +150 °C	90 min @ +125 °C 20 min @ +150 °C	30 min @ +150 °C	30 min @ +60 °C	30 min @ +60 °C	90 min @ +60 °C 15 min @ +90 °C	30 min @ +80 °C 10 min @ +100 °C	8 min @ +120 °C 2 min @ +150 °C	15 min @ +130°C	5 min @ +130 °C 2 min @ +150 °C	60 min @ +90 °C 15 min @ +130 °C
Temperature range of use [°C]		-55 to +200	-55 to +200	-55 to +220	-40 to +180	-40 to +180	-40 to +150	-40 to +200	-65 to +180	-65 to +180	-65 to +180	-40 to +150	-40 to +150	-40 to +150	-40 to +130	-40 to +180	-40 to +130	-40 to +150	-40 to +180
Glass transition temperature T _g [°C]	DMTA	+130	+134	+168	+126	+93	+76	+155	-	-	-	+25	+56	+33	-	-	-	-	+143
	TMA	-	-	-	-	-	-	-	+144	+182	+196	-	-	-	+80	+139	-52	+72	-
Compression shear strength [MPa]	AI/AI	52	57	65	60	68	28	41	15	20	-	12	30	20	26	48	8	-	48
	FR4/FR4	-	-	-	-	72	25	25	54	50	46	-	35	25	36	-	-	-	55
	PPS/PPS	-	-	22	27	22	-	-	25	-	21	-	-	-	-	-	-	-	-
Tensile shear strength [MPa]	at rt	33	25	22	20	22	-	-	-	-	-	11	-	-	-	-	-	-	-
by the criteria of DIN 1465	at +150°C	6	8	18	4	-	-	20	-	-	-	-	-	-	-	-	-	-	-
Tensile strength [MPa] by the criteria of DIN EN ISO 527		64	71	69	66	70	15	60	59	55	50	5	56	22	15	40	6	33	33
Elongation at tear [%] by the criteria of DIN EN ISO 527		3	2	3	3	3	150	<1	<1	<1	<1	90	2	70	20	1	350	19	1
Young's modulus [MPa]	by the criteria of DIN EN ISO 527	3,800	5,500	4,400	-	-	-	13,000	12,300	11,000	9,600	-	-	180	500	-	19	1,400	3,200
	DMTA	-	-	-	4,000	2,900	800	-	-	-	-	100	5,700	-	-	3,200	-	-	-
Shore hardness by the criteria of DIN EN ISO 868		D 80	D 89	D 86	D 85	D 81	D 49	D 92	D 87	D 89	D 90	A 76	D 84	D 69	D 72	D 86	A 58	D 78	D 80
Coefficient of linear expansion [ppm/K]	below T _g	61	35	50	68	70	77	23	11	22	20	73	46	57	150	58	74	94	65
TMA, DELO Standaro 20	above T _g	187	153	148	175	193	268	48	43	_	_	188	161	185	179	170	220	168	181
Shrinkage [vol. %] DELO Standard 26		2.50	2.00	1.50	3.00	3.00	-	-	1.20	1.40	-	3.80	4.00	4.90	2.40	1.70	0.61	3.80	2.90
Water absorption [weight %] by the criteria of DIN EN ISO 62		0.18	0.14	0.20	0.20	0.10	0.40	0.10	0.10	0.10	-	0.60	0.10	0.20	0.20	0.20	-	0.50	0.20
Preservability		6 months @ 0 to +10 °C	6 months @ 0 to +10°C	6 months @ 0 to +10°C	6 months @ 0 to +10 °C	6 months @ 0 to +10°C	3 months @ 0 to +10 °C (expected: 6 months)	6 months @ 0 to +10°C	6 months @ -40 °C	6 months @ -18°C	6 months @ -18°C	4 months @ – 18 °C (expected: 6 months)	6 months @ -18°C	6 months @ -18°C	6 months @ –18 °C	6 months @ -18°C	3 months @ – 18 °C (expected: 6 months)	6 months @ -18°C	6 months @ -18°C
Special features of product		very high strength very high media resistance	high-strength connections with very high static and dynamic loads flow-resistant	very high temperature and media resistance	fast fixation of the components by light adjusted flow behavior	halogen-free good flow behavior especially for use in electronics	good suitability as climate-resistant sealant for mixed bondings high impact resistance	encapsulation of electronic components very high temperature and media resistance	fill very good flow behavior	dam flow-resistant	fast fixation strength glob top	curing at very low temperatures flexible	suitable for temperature-sensitive components	suitable for temperature-sensitive components	extremely fast fixation strength very steady shrinkage optimized for high-precision optical bonding	fast thermode curing possible (6 s @ +180 °C) very good adhesion to FR4, gold, preplated leadframe, aluminum and LCP	especially for screen and stencil printing use in "low-stress" applications	ideal in combination with UV-curing chip encapsulants DELO KATIOBOND	very fast light fixation very good adhesion to FR4, gold, preplated leadframe, aluminum and LCP

AD = ADhesive DA = Die Attach GE = General Encapsulant HT = High Temperature LT = Low Temperature SJ = Structural Joining